inter_{sil}

36V Rad Hard Dual Precision Operational Amplifier

ISL70227SRH

The ISL70227SRH is a high precision dual operational amplifier featuring very low noise, low offset voltage, low input bias current and low temperature drift. These features plus its radiation tolerance make the ISL70227SRH the ideal choice for applications requiring both high DC accuracy and AC performance. The combination of precision, low noise, and small footprint provides the user with outstanding value and flexibility relative to similar competitive parts.

Applications for these amplifiers include precision and analytical instrumentation, active filters, precision power supply controls, and industrial controls.

The ISL70227SRH is available in a 10 Ld hermetic ceramic flatpack and operates over the extended temperature range of -55°C to +125°C.

Applications

- Precision Instruments
- Industrial Controls
- Active Filter Blocks
- Data Acquisition
- Power Supply Control

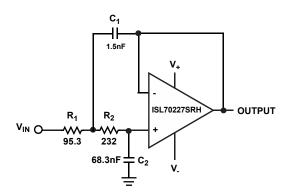
Features

 Wide Supply Range 	4.5V to 36V Max.
---------------------------------------	------------------

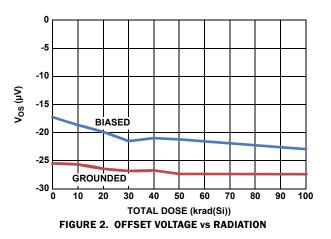
- Gain-bandwidth Product 10MHz
- Superb Offset Drift 1µV/°C, Max
- Operating Temperature Range......55°C to +125°
- Low Input Voltage Offset 10µV, Typ.
- Input Bias Current1nA, Typ.
- Unity Gain Stable
- No Phase Reversal
- Radiation Tolerance
 - High Dose Rate..... 100krad(Si)
 - Low Dose Rate 100krad(Si)

Related Literature

• See <u>AN1669</u>, "ISL70227SRH Evaluation Board User's Guide"



Sallen-Key Low Pass Filter (1MHz) FIGURE 1. TYPICAL APPLICATION



Ordering Information

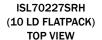
ORDERING NUMBER	PART MARKING	TEMP RANGE (°C)	PACKAGE (Pb-free)	PKG. DWG. #
ISL70227SRHMF (Notes 1, 2)	ISL70227 SRHMF	-55 to +125	10 Ld FLATPACK	K10.A
ISL70227SRHF/PROTO (Notes 1, 2)	ISL70227 SRHF/PR0T0	-55 to +125	10 Ld FLATPACK	K10.A
ISL70227SRHMX		-55 to +125	DIE	
ISL70227SRHX/SAMPLE		-55 to +125	DIE	
ISL70227MHEVAL1Z	Evaluation Board			

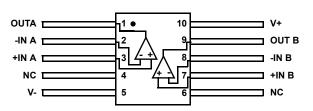
NOTES:

1. These Intersil Pb-free Hermetic packaged products employ 100% Au plate - e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations.

2. For Moisture Sensitivity Level (MSL), please see device information page for ISL70227SRH. For more information on MSL please see techbrief TB363.

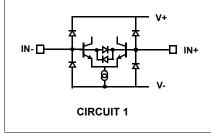
Pin Configuration

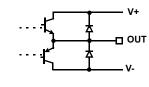




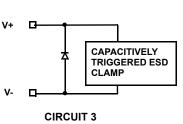
Pin Descriptions

PIN NUMBER	PIN NAME	EQUIVALENT CIRCUIT	DESCRIPTION
3	+IN_A	Circuit 1	Amplifier A non-inverting input
5	V-	Circuit 3	Negative power supply
7	+IN_B	Circuit 1	Amplifier B non-inverting input
8	-IN_B	Circuit 1	Amplifier B inverting input
9	OUT B	Circuit 2	Amplifier B output
10	V+	Circuit 3	Positive power supply
1	OUT A	Circuit 2	Amplifier A output
2	-IN_A	Circuit 1	Amplifier A inverting input
4, 6	NC	-	Not Connected – This pin is not electrically connected internally.









Absolute Maximum Ratings

Maximum Supply Voltage 36V Maximum Differential Input Current 20mA Maximum Differential Input Voltage 0.5V Min/Max Input Voltage 0.5V Max/Min Input Current for V 0.5V to V+ + 0.5V
Input Voltage >V+ or <v< td=""></v<>
(1 Output at a Time) Indefinite ESD Tolerance
Human Body Model (Tested per JESD22-A114F). 2kV Machine Model (Tested per EIA/JESD22-A115-A). 300V Charged Device Model (Tested per JESD22-C101D) 750V Di-electrically Isolated PR40 Process Latch-up free

Thermal Information

Thermal Resistance (Typical)	θ_{JA} (°C/W)	θ _{JC} (°C/W)
10 Ld Ceramic Flatpack (Notes 3, 4)	130	20
Storage Temperature Range	6	5°C to +150°C

Recommended Operating Conditions

Ambient Operating Temperature Range	55°C to +125°C
Maximum Operating Junction Temperature	+150°C
Supply Voltage	5V (±2.5V) to 30V (±15V)

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

3. θ_{IA} is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief <u>TB379</u> for details.

4. For θ_{JC} the "case temp" location is the center of the exposed metal pad on the package underside.

Electrical Specifications $V_{S} \pm 15V$, $V_{CM} = 0$, $V_{0} = 0V$, $R_{L} = 0$ pen, $T_{A} = +25$ °C, unless otherwise noted. Boldface limits apply over the operating temperature range, -55°C to +125°C, and over the radiation tolerance limit with exposure at a high dose rate.

PARAMETER	DESCRIPTION	CONDITIONS	MIN (Note 5)	TYP	MAX (Note 5)	UNIT
V _{OS}	Offset Voltage		-75	-10	75	μV
			-100	-	100	μV
TCV _{OS}	Offset Voltage Drift		-1	.1	1	µV∕°C
I _{OS}	Input Offset Current		-10	1	10	nA
			-12	-	12	nA
I _B	Input Bias Current		-10	1	10	nA
			-12	-	12	nA
V _{CM}	Input Voltage Range	Guaranteed by CMRR	-13	-	13	v
			-12	-	12	v
CMRR	Common-Mode Rejection Ratio	V _{CM} = -13V to +13V	115	120	-	dB
		V _{CM} = -12V to +12V	115	-	-	dB
PSRR	Power Supply Rejection Ratio	$V_{S} = \pm 2.25V \text{ to } \pm 5V$	110	117	-	dB
		$V_{S} = \pm 3V$ to $\pm 15V$	110	-	-	dB
A _{VOL}	Open-Loop Gain	$V_0 = -13V$ to $+13V$ $R_L = 10k\Omega$ to ground	1000	1500	-	V/mV
V _{OH}	Output Voltage High	utput Voltage High $R_L = 10k\Omega$ to ground	13.5	13.65	-	v
			13.2	-	-	v
		$R_L = 2k\Omega$ to ground	13.4	13.5	-	v
			13.1	-	-	v
V _{OL}	Output Voltage Low	$R_L = 10k\Omega$ to ground	-	-13.65	-13.5	v
			-	-	-13.2	v
		$R_L = 2k\Omega$ to ground	-	-13.5	-13.4	v
			-	-	-13.1	v

ISL70227SRH

Electrical Specifications $V_{S} \pm 15V$, $V_{CM} = 0$, $V_{0} = 0V$, $R_{L} = Open$, $T_{A} = +25$ °C, unless otherwise noted. Boldface limits apply over the operating temperature range, -55°C to +125°C, and over the radiation tolerance limit with exposure at a high dose rate. (Continued)

PARAMETER	DESCRIPTION	CONDITIONS	MIN (Note 5)	ТҮР	MAX (Note 5)	UNIT
ا _S	Supply Current/Amplifier		-	2.2	2.8	mA
			-	-	3.7	mA
I _{SC}	Short-Circuit	$R_L = 0\Omega$ to ground	-	±45	-	mA
V _{SUPPLY}	Supply Voltage Range	Guaranteed by PSRR	±2.25	-	±15	v
AC SPECIFICATI	ONS					
GBW	Gain Bandwidth Product		-	10	-	MHz
e _{np-p}	Voltage Noise	0.1Hz to 10Hz	-	85	-	nV _{P-P}
e _n	Voltage Noise Density	f = 10Hz	-	3	-	nV/√Hz
e _n	Voltage Noise Density	f = 100Hz	-	2.8	-	nV/√Hz
e _n	Voltage Noise Density	f = 1kHz	-	2.5	-	nV/√Hz
e _n	Voltage Noise Density	f = 10kHz	-	2.5	-	nV/√Hz
in	Current Noise Density	f = 10kHz	-	0.4	-	pA/√Hz
THD + N	Total Harmonic Distortion + Noise	$1 \text{kHz, G} = 1, V_0 = 3.5 V_{\text{RMS}},$ $R_L = 2 \text{k}\Omega$	-	0.00022	-	%
RANSIENT RES	SPONSE			1	L L	
SR	Slew Rate	$A_V = 10, R_L = 2k\Omega, V_0 = 4V_{P-P}$	-	±3.6	-	V/µs
t _r , t _f , Small Signal	Rise Time 10% to 90% of V _{OUT}	$\begin{aligned} \textbf{A}_{V} &= \textbf{-1}, \textbf{V}_{OUT} = \textbf{100mV}_{P.P'} \\ \textbf{R}_{f} &= \textbf{R}_{g} = 2k\Omega, \textbf{R}_{L} = 2k\Omega \text{ to } \textbf{V}_{CM} \end{aligned}$	-	36	-	ns
	Fall Time 90% to 10% of V _{OUT}	$A_{V} = -1, V_{OUT} = 100 \text{mV}_{\text{P-P}},$ $R_{f} = R_{g} = 2k\Omega, R_{L} = 2k\Omega \text{ to } V_{\text{CM}}$	-	38	-	ns
t _s	Settling Time to 0.1% 10V Step; 10% to V _{OUT}		-	3.4	-	μs
	Settling Time to 0.01% 10V Step; 10% to V _{OUT}		-	3.8	-	μs
t _{OL}	Output Overload Recovery Time	$A_V = 100, V_{IN} = 0.2V,$ $R_L = 2k\Omega$ to V_{CM}	-	1.7	-	μs

Electrical Specifications $V_{S} \pm 5V$, $V_{CM} = 0$, $V_{0} = 0V$, $T_{A} = +25$ °C, unless otherwise noted. Boldface limits apply over the operating temperature range, -55°C to +125°C.

PARAMETER	DESCRIPTION	CONDITIONS	MIN (Note 5)	ТҮР	MAX (Note 5)	UNIT
V _{os}	Offset Voltage		-	-10	-	μV
TCV _{OS}	Offset Voltage Drift		-	.1	-	µV∕°C
I _{OS}	Input Offset Current		-	1	-	nA
I _B	Input Bias Current		-	1	-	nA
CMRR	Common-Mode Rejection Ratio	$V_{CM} = -3V$ to $+3V$	-	120	-	dB
PSRR	Power Supply Rejection Ratio	$V_S = \pm 2.25V$ to $\pm 5V$	-	125	-	dB
A _{VOL}	Open-Loop Gain	$V_0 = -3V \text{ to } +3V$ $R_L = 10k\Omega \text{ to ground}$	-	1500	-	V/mV
V _{OH} Output Voltage High	$R_L = 10k\Omega$ to ground	-	3.65	-	v	
		$R_L = 2k\Omega$ to ground	-	3.5	-	

Electrical Specifications $V_{S} \pm 5V$, $V_{CM} = 0$, $V_{0} = 0V$, $T_{A} = +25$ °C, unless otherwise noted. Boldface limits apply over the operating temperature range, -55°C to +125°C. (Continued)

PARAMETER	DESCRIPTION	CONDITIONS	MIN (Note 5)	ТҮР	MAX (Note 5)	UNIT
V _{OL}	Output Voltage Low	$R_L = 10k\Omega$ to ground	-	-3.65	-	v
		$R_L = 2k\Omega$ to ground	-	-3.5	-	
۱ _S	Supply Current/Amplifier		-	2.2	-	mA
I _{SC}	Short-Circuit		-	±45	-	mA
AC SPECIFICAT	IONS				I	
GBW	Gain Bandwidth Product		-	10	-	MHz
THD + N	Total Harmonic Distortion + Noise	1kHz, G = 1, Vo = $2.5V_{RMS}$, R _L = $2k\Omega$	-	0.0034	-	%
RANSIENT RE	SPONSE		4	L	· · ·	
SR	Slew Rate	$A_V = 10, R_L = 2k\Omega$	-	±3.6	-	V/µs
t _r , t _f , Small Signal	Rise Time 10% to 90% of V _{OUT}		-	36	-	ns
	Fall Time 90% to 10% of V _{OUT}		-	38	-	ns
t _s	Settling Time to 0.1%		-	1.6	-	μs
	Settling Time to 0.01%	$A_{V} = -1, V_{OUT} = 4V_{P-P}$ $R_{f} = R_{g} = 2k\Omega, R_{L} = 2k\Omega \text{ to } V_{CM}$	-	4.2	-	μs

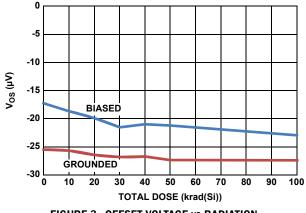
NOTE:

5. Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.

Post Radiation Characteristics	$V_{S} \pm 15V$, $V_{CM} = 0V$, $V_{0} = 0V$, $R_{L} = 0$ pen, $T_{A} = +25$ °C, unless otherwise noted. This data is ATE test
	t a high dose rate of 50 to 300rad(SI)/s, these are not limits nor are they guaranteed.

PARAMETER	DESCRIPTION	CONDITIONS	50k RAD	75k RAD	100k RAD	UNIT
V _{OS}	Offset Voltage		34	30	30	μV
I _{OS}	Input Offset Current		-1	-1	-2	nA
I _B	Input Bias Current		-1	-2	-3	nA
CMRR	Common-Mode Rejection Ration	V _{CM} = -13V to +13V	155	155	155	dB
PSRR	Power Supply Rejection Ratio	$V_{S} = \pm 2.25V \text{ to } \pm 15V$	116	116	116	dB
A _{VOL}	Open-Loop Gain	$V_0 = -13V$ to $+13V$ $R_L = 10k\Omega$ to ground	3500	3500	3500	V/mV
اج ا	Supply Current/Amplifier		2.2	2.2	2.2	mA

Post Radiation Characteristics $v_{S \pm 15V}$, $v_{CM} = 0V$, $v_{O} = 0V$, $R_{L} = 0$ pen, $T_{A} = +25$ °C, unless otherwise noted. This data is ATE test data of the ISL70227SRH post radiation exposure at a low dose rate of <10mrad(SI)/s, these are not limits nor are they guaranteed.





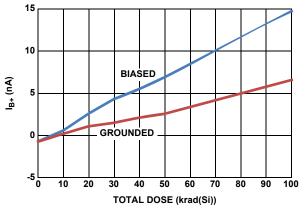


FIGURE 4. POSITIVE INPUT BIAS CURRENT vs RADIATION

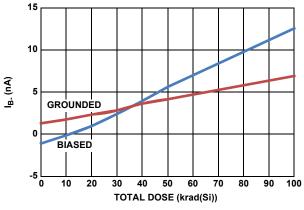
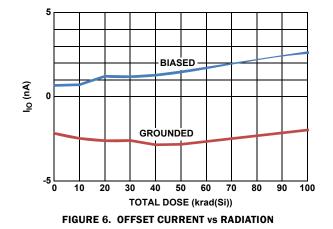
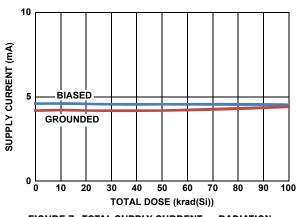


FIGURE 5. NEGATIVE INPUT BIAS CURRENT vs RADIATION







Typical Performance Curves $v_s = \pm 15V$, $v_{CM} = 0V$, $R_L = Open$, unless otherwise specified.

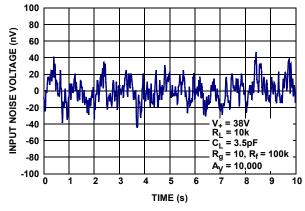


FIGURE 8. INPUT NOISE VOLTAGE 0.1Hz TO 10Hz

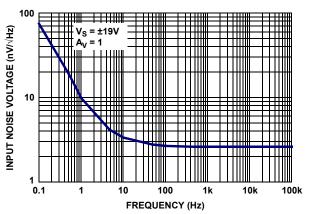


FIGURE 9. INPUT NOISE VOLTAGE SPECTRAL DENSITY

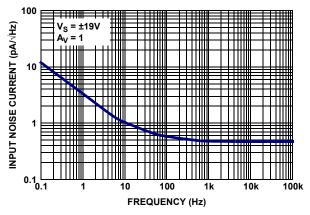


FIGURE 10. INPUT NOISE CURRENT SPECTRAL DENSITY

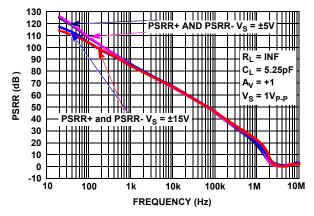


FIGURE 11. PSRR vs FREQUENCY, $V_S = \pm 5V, \pm 15V$

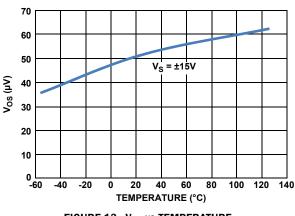


FIGURE 13. V_{OS} vs TEMPERATURE

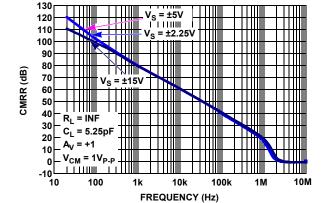
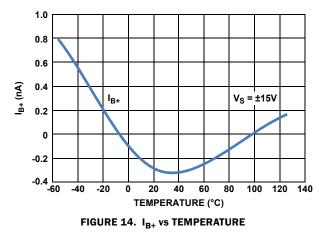
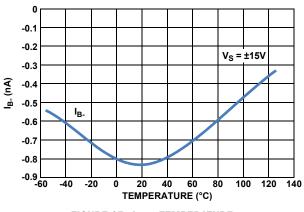
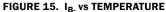


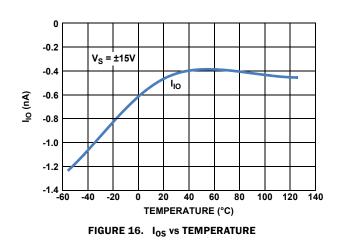
FIGURE 12. CMRR vs FREQUENCY, $V_S = \pm 2.25, \pm 5V, \pm 15V$

Typical Performance Curves $V_{s} = \pm 15V$, $V_{CM} = 0V$, $R_{L} = Open$, unless otherwise specified. (Continued)









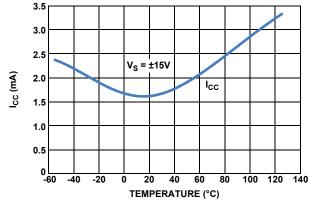


FIGURE 17. SUPPLY CURRENT vs TEMPERATURE

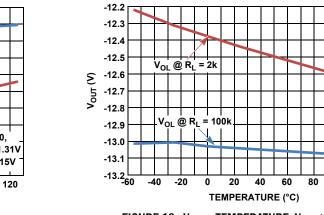


FIGURE 19. V_{OL} vs TEMPERATURE, $V_S = \pm 15V$

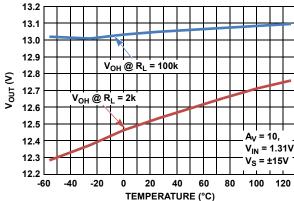


FIGURE 18. V_{OH} vs TEMPERATURE, $V_S = \pm 15V$

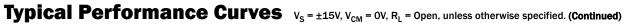
A_V = 10,

100 120

V_{IN} = - 1.31V

V_S = ±15V

ISL70227SRH



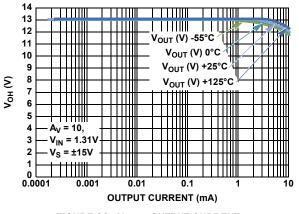


FIGURE 20. V_{OH} vs OUTPUT CURRENT

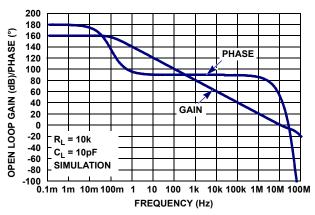


FIGURE 21. OPEN-LOOP GAIN, PHASE vs FREQUENCY, R_L = 10k $\Omega,$ C_L = 10pF

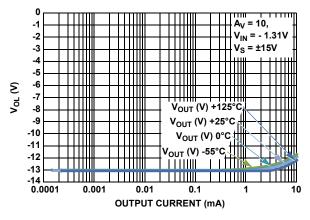


FIGURE 22. V_{OL} vs OUTPUT CURRENT

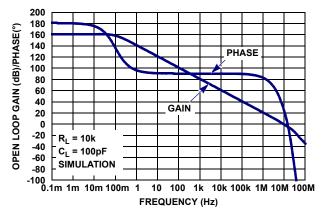
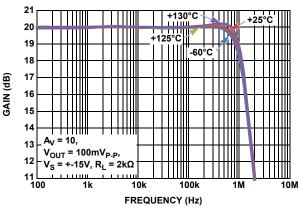


FIGURE 23. OPEN-LOOP GAIN, PHASE vs FREQUENCY, \textbf{R}_L = 10k $\Omega,$ \textbf{C}_L = 100pF





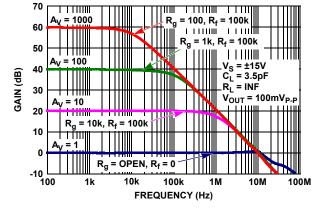


FIGURE 24. FREQUENCY RESPONSE vs CLOSED LOOP GAIN

1

Typical Performance Curves $v_s = \pm 15V$, $v_{CM} = 0V$, $R_L = Open$, unless otherwise specified. (Continued)

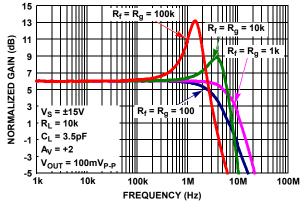


FIGURE 26. FREQUENCY RESPONSE vs FEEDBACK RESISTANCE $${\rm R_{f\prime}/R_g}$$

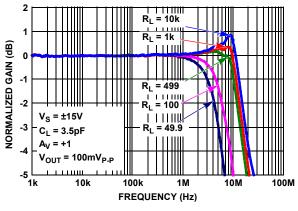
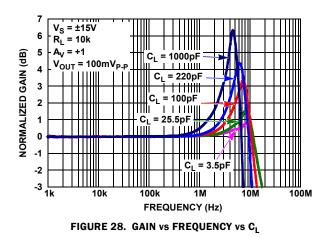


FIGURE 27. GAIN vs FREQUENCY vs RL

V_S = ±2.25V



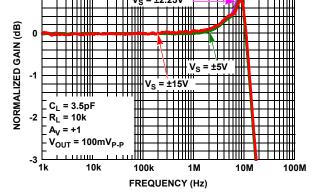


FIGURE 29. GAIN vs FREQUENCY vs SUPPLY VOLTAGE

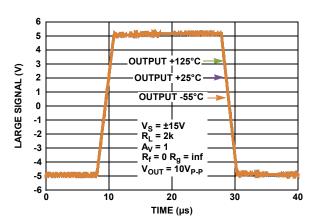


FIGURE 31. LARGE SIGNAL 10V STEP RESPONSE, $V_S = \pm 15V vs$ TEMPERATURE

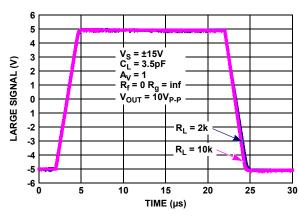
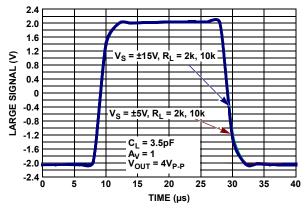
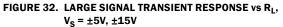
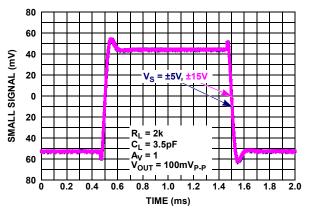


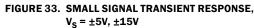
FIGURE 30. LARGE SIGNAL 10V STEP RESPONSE, $V_S = \pm 15V$

Typical Performance Curves $v_s = \pm 15V$, $v_{CM} = 0V$, $R_L = Open$, unless otherwise specified. (Continued)









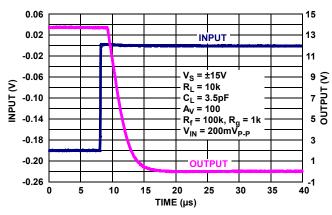


FIGURE 34. POSITIVE OUTPUT OVERLOAD RESPONSE TIME, $V_S=\pm 15V$

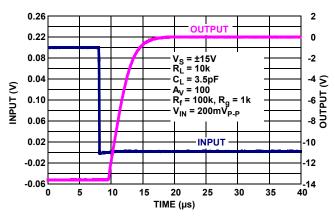


FIGURE 35. NEGATIVE OUTPUT OVERLOAD RESPONSE TIME, $V_{S}=\pm15V$

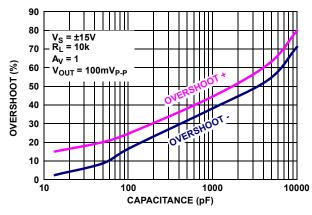


FIGURE 36. % OVERSHOOT vs LOAD CAPACITANCE, Vs = ±15V

Applications Information

Functional Description

The ISL70227SRH is a dual, low noise 10MHz BW precision op amp fabricated in a new precision 40V complementary bipolar DI process. A super-beta NPN input stage with input bias current cancellation provides low input bias current (1nA typical), low input offset voltage (10µV typ), low input noise voltage (3nV/ \sqrt{Hz}), and low 1/f noise corner frequency (5Hz). These amplifiers also feature high open loop gain (1500V/mV) for excellent CMRR (120dB) and THD+N performance (0.0002% @ 3.5V_{RMS}, 1kHz into 2kΩ). A complimentary bipolar output stage enables high capacitive load drive without external compensation.

Operating Voltage Range

The devices are designed to operate over the 4.5V ($\pm 2.25V$) to 36V ($\pm 18V$) range and are fully characterized at 30V ($\pm 15V$). Parameter variation with operating voltage is shown in the "Typical Performance Curves" beginning on page 7.

Input ESD Diode Protection

The input terminals (IN+ and IN-) have internal ESD protection diodes to the positive and negative supply rails, and an additional anti-parallel diode pair across the inputs (see Figures 37 and 38).

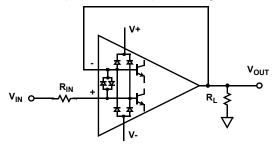


FIGURE 37. INPUT ESD DIODE CURRENT LIMITING - UNITY GAIN

For unity gain applications (see Figure 37) where the output is connected directly to the non-inverting input a current limiting resistor ($\rm R_{IN}$) will be needed under the following conditions to protect the anti-parallel differential input protection diodes.

- The amplifier input is supplied from a low impedance source.
- The input voltage rate-of-rise (dV/dt) exceeds the maximum slew rate of the amplifier ($\pm 3.6V/\mu s).$

If the output lags far enough behind the input, the anti-parallel input diodes can conduct. For example, if an input pulse ramps from 0V to +10V in 1µs, then the output of the ISL70227SRH will reach only +3.6V (slew rate = 3.6V/µs) while the input is at 10V, The input differential voltage of 6.4V will force input ESD diodes to conduct, dumping the input current directly into the output stage and the load. The resulting current flow can cause permanent damage to the ESD diodes. The ESD diodes are rated to 20mA, and in the previous example, setting R_{IN} to 1k resistor (see Figure 37) would limit the current to <6.4mA, and provide additional protection up to \pm 20V at the input.

In applications where one or both amplifier input terminals are at risk of exposure to high voltage, current limiting resistors may be needed at each input terminal (see Figure 38 R_{IN} +, R_{IN} -) to limit current through the power supply ESD diodes to 20mA.

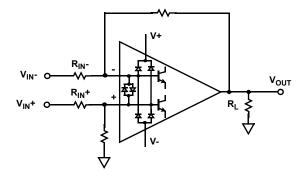


FIGURE 38. INPUT ESD DIODE CURRENT LIMITING - DIFFERENTIAL INPUT

Output Current Limiting

The output current is internally limited to approximately ± 45 mA at +25 °C and can withstand a short circuit to either rail as long as the power dissipation limits are not exceeded. This applies to only 1 amplifier at a time. Continuous operation under these conditions may degrade long term reliability.

Output Phase Reversal

Output phase reversal is a change of polarity in the amplifier transfer function when the input voltage exceeds the supply voltage. The ISL70227SRH are immune to output phase reversal, even when the input voltage is 1V beyond the supplies.

Power Dissipation

It is possible to exceed the +150 °C maximum junction temperatures under certain load and power supply conditions. It is therefore important to calculate the maximum junction temperature (T_{JMAX}) for all applications to determine if power supply voltages, load conditions, or package type need to be modified to remain in the safe operating area. These parameters are related using Equation 1:

$$T_{JMAX} = T_{MAX} + \theta_{JA} X P D_{MAXTOTAL}$$
(EQ. 1)

where:

- P_{DMAXTOTAL} is the sum of the maximum power dissipation of each amplifier in the package (PD_{MAX})
- PD_{MAX} for each amplifier can be calculated using Equation 2:

$$PD_{MAX} = V_{S} \times I_{qMAX} + (V_{S} - V_{OUTMAX}) \times \frac{V_{OUTMAX}}{R_{L}}$$
(EQ. 2)

where:

- T_{MAX} = Maximum ambient temperature
- θ_{JA} = Thermal resistance of the package
- PD_{MAX} = Maximum power dissipation of 1 amplifier
- V_S = Total supply voltage
- I_{qMAX} = Maximum quiescent supply current of 1 amplifier
- V_{OUTMAX} = Maximum output voltage swing of the application
- R_L = Load resistance

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest Rev.

REVISION	DATE	CHANGE			
FN7925.1	, ,	Added "Related Literature" on page 1. Made correction to Ordering Information - Eval board name changed from "ISL70227SRHEVAL1Z" TO "ISL70227MHEVAL1Z"			
FN7925.0	9/7/11	Initial Release.			

Products

Intersil Corporation is a leader in the design and manufacture of high-performance analog semiconductors. The Company's products address some of the industry's fastest growing markets, such as, flat panel displays, cell phones, handheld products, and notebooks. Intersil's product families address power management and analog signal processing functions. Go to <u>www.intersil.com/products</u> for a complete list of Intersil product families.

For a complete listing of Applications, Related Documentation and Related Parts, please see the respective device information page on intersil.com: <u>ISL70227SRH</u>

To report errors or suggestions for this datasheet, please go to www.intersil.com/askourstaff

FITs are available from our website at: http://rel.intersil.com/reports/search.php

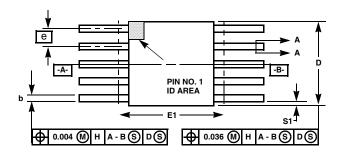
For additional products, see <u>www.intersil.com/product_tree</u>

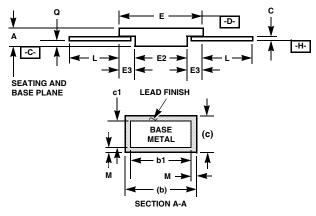
Intersil products are manufactured, assembled and tested utilizing ISO9000 quality systems as noted in the quality certifications found at www.intersil.com/design/quality

Intersil products are sold by description only. Intersil Corporation reserves the right to make changes in circuit design, software and/or specifications at any time without notice. Accordingly, the reader is cautioned to verify that data sheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

For information regarding Intersil Corporation and its products, see www.intersil.com

Ceramic Metal Seal Flatpack Packages (Flatpack)





NOTES:

- Index area: A notch or a pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark. Alternately, a tab (dimension k) may be used to identify pin one.
- 2. If a pin one identification mark is used in addition to a tab, the limits of dimension k do not apply.
- 3. This dimension allows for off-center lid, meniscus, and glass overrun.
- 4. Dimensions b1 and c1 apply to lead base metal only. Dimension M applies to lead plating and finish thickness. The maximum limits of lead dimensions b and c or M shall be measured at the centroid of the finished lead surfaces, when solder dip or tin plate lead finish is applied.
- 5. N is the maximum number of terminal positions.
- 6. Measure dimension S1 at all four corners.
- 7. For bottom-brazed lead packages, no organic or polymeric materials shall be molded to the bottom of the package to cover the leads.
- Dimension Q shall be measured at the point of exit (beyond the meniscus) of the lead from the body. Dimension Q minimum shall be reduced by 0.0015 inch (0.038mm) maximum when solder dip lead finish is applied.
- 9. Dimensioning and tolerancing per ANSI Y14.5M 1982.
- 10. Controlling dimension: INCH.

K10.A MIL-STD-1835 CDFP3-F10 (F-4A, CONFIGURATION B) 10 LEAD CERAMIC METAL SEAL FLATPACK PACKAGE

	INCHES		MILLIMETERS		
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А	0.045	0.115	1.14	2.92	-
b	0.015	0.022	0.38	0.56	-
b1	0.015	0.019	0.38	0.48	-
С	0.004	0.009	0.10	0.23	-
c1	0.004	0.006	0.10	0.15	-
D	-	0.290	-	7.37	3
Е	0.240	0.260	6.10	6.60	-
E1	-	0.280	-	7.11	3
E2	0.125	-	3.18	-	-
E3	0.030	-	0.76	-	7
е	0.050 BSC		1.27 BSC		-
k	0.008	0.015	0.20	0.38	2
L	0.250	0.370	6.35	9.40	-
Q	0.026	0.045	0.66	1.14	8
S1	0.005	-	0.13	-	6
М	-	0.0015	-	0.04	-
Ν	10		10		-

Rev. 0 3/07